P-Channel 30V (D-S) MOSFET

GENERAL DESCRIPTION

The ME7835S P-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where high-side switching , and low in-line power loss are needed in a very small outline surface mount package.

FEATURES

- RDS(ON) ≦18mΩ@VGS=-10V
- RDS(ON) ≦36mΩ@VGS=-4.5V

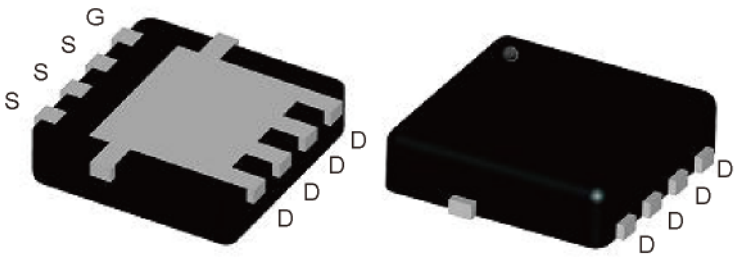
APPLICATIONS

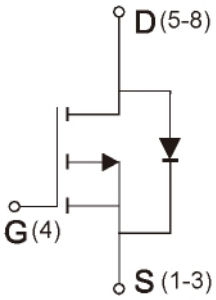
- Power Management in Note book
- Portable Equipment
- Battery Powered System
- Load Switch
- DSC

PIN CONFIGURATION

(DFN(S) 3.3x3.3)

Top View





Ordering Information: ME7835S-G (Green product-Halogen free)

Absolute Maximum Ratings (TA=25℃ Unless Otherwise Noted)

Parameter		Symbol	Maximum Ratings	Unit
Drain-Source Voltage		V_{DS}	-30	V
Gate-Source Voltage		V_{GS}	±25	V
Continuous Drain Current	T_A=25℃	I_D	-11.5	A
	T_A=70℃		-9.2	
Pulsed Drain Current		I_{DM}	-46	A
Maximum Power Dissipation	T_A=25℃	P_D	3.8	W
	T_A=70℃		2.4	
Operating Junction Temperature		T_J	-55 to 150	℃
Thermal Resistance-Junction to Ambient*		$R_{\theta JA}$	33	℃/W

*The device mounted on 1in^2 FR4 board with 2 oz copper

P-Channel 30V (D-S) MOSFET

Electrical Characteristics (T_A=25℃ Unless Otherwise Specified)

Symbol	Parameter	Limit	Min	Typ	Max	Unit
STATIC						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V, I_D=-250μA	-30			V
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=-250μA	-1		-3	V
I_{GSS}	Gate Leakage Current	V_{DS}=0V, V_{GS}=±25V			±100	nA
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=-30V, V_{GS}=0V			-1	μA
$R_{DS(ON)}$	Drain-Source On-State Resistance [a]	V_{GS}=-10V, I_D= -8.5A		15	18	mΩ
		V_{GS}=-4.5V, I_D= -6.3A		27	36	
V_{SD}	Diode Forward Voltage	I_S=-8.5A, V_{GS}=0V		-0.85	-1.2	V
DYNAMIC						
Qg	Total Gate Charge	V_{DS}=-15V,V_{GS}=-10V, I_D=-8.5A		29.7		nC
Qg	Total Gate Charge	V_{DS}=-15V,V_{GS}=-4.5V, I_D=-8.5A		15		
Qgs	Gate-Source Charge			7.8		
Qgd	Gate-Drain Charge			8.6		
Ciss	Input Capacitance	V_{DS}=-15V, V_{GS}=0V,f=1MHz		1290		pF
Coss	Output Capacitance			217		
Crss	Reverse Transfer Capacitance			152		
$t_{d(on)}$	Turn-On Delay Time	V_{DS}=-15V, R_L =15Ω R_{GEN}=6Ω, V_{GS}=-10V		42		ns
t_r	Turn-On Rise Time			18		
$t_{d(off)}$	Turn-Off Delay Time			81		
t_f	Turn-Off Fall Time			18		

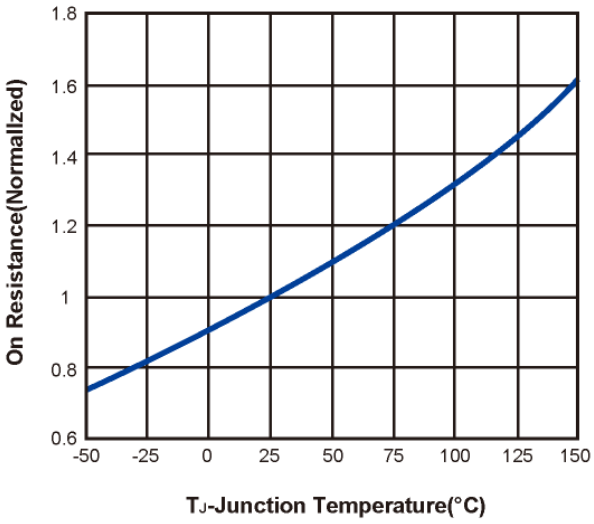
Note: a. Pulse test: pulse width≦300us, duty cycle≦2%

b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.

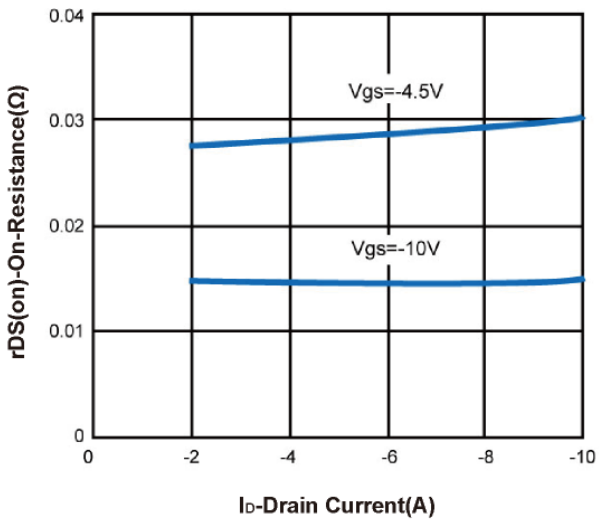
P-Channel 30V (D-S) MOSFET

Typical Characteristics (T_J =25℃ Noted)

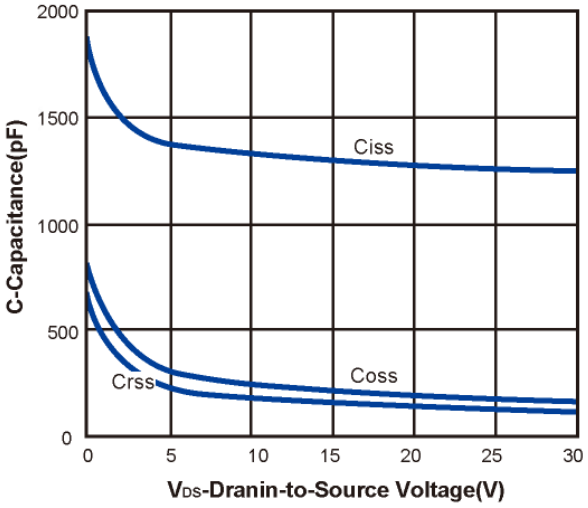
On Resistance vs. Junction Temperature



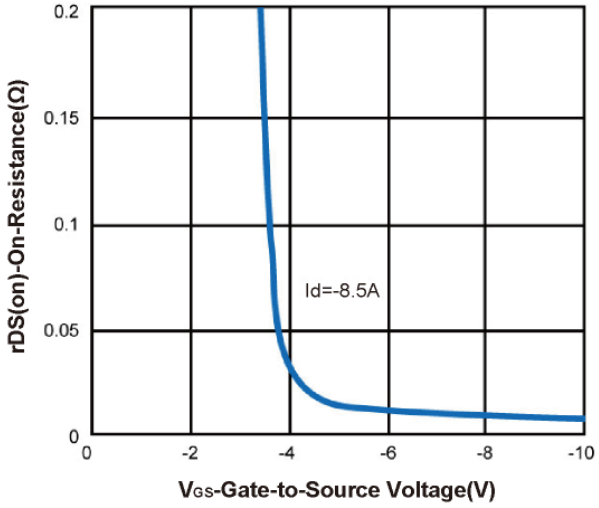
On Resistance vs. Drain Current



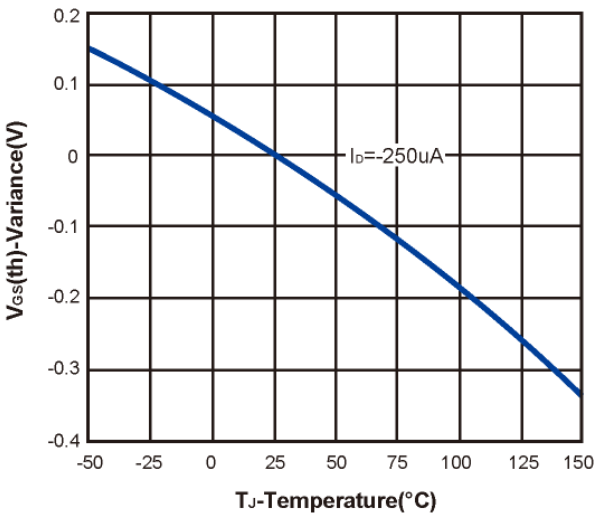
Capacitance



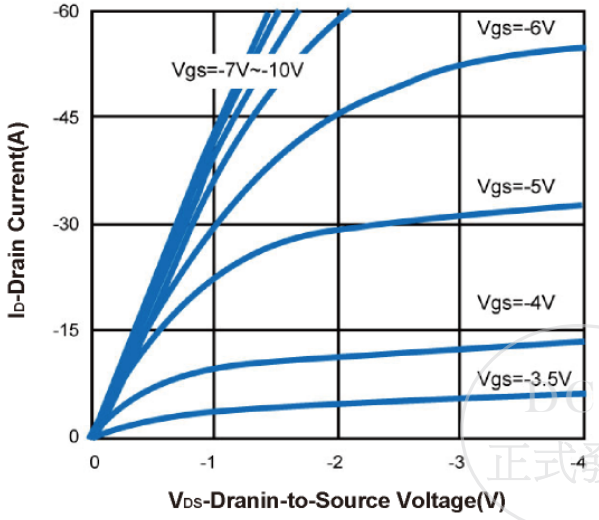
On Resistance vs. Gate-to-Source Voltage



Threshold Voltage



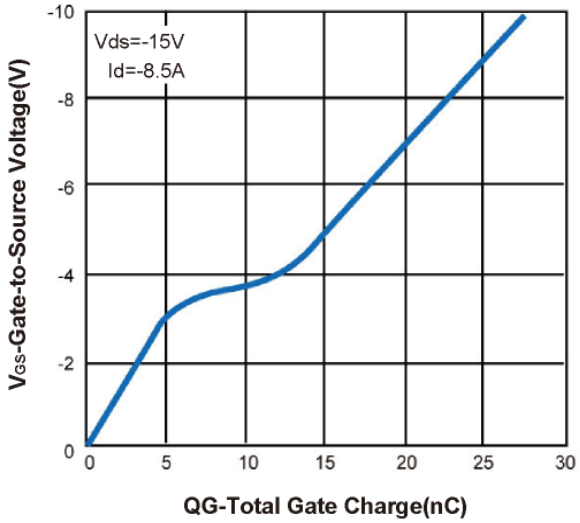
On-Region Characteristics



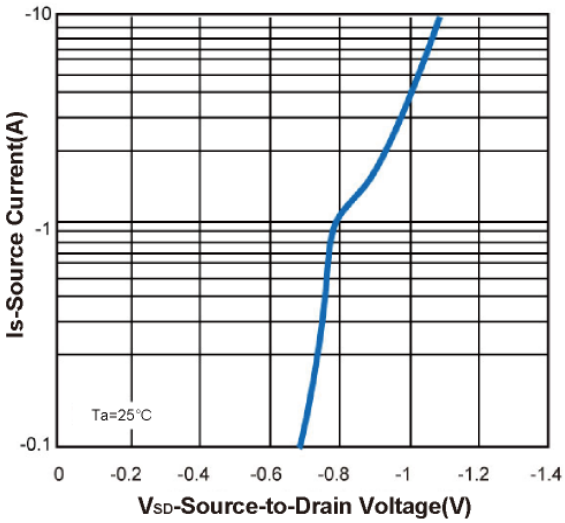
P-Channel 30V (D-S) MOSFET

Typical Characteristics (T_J =25℃ Noted)

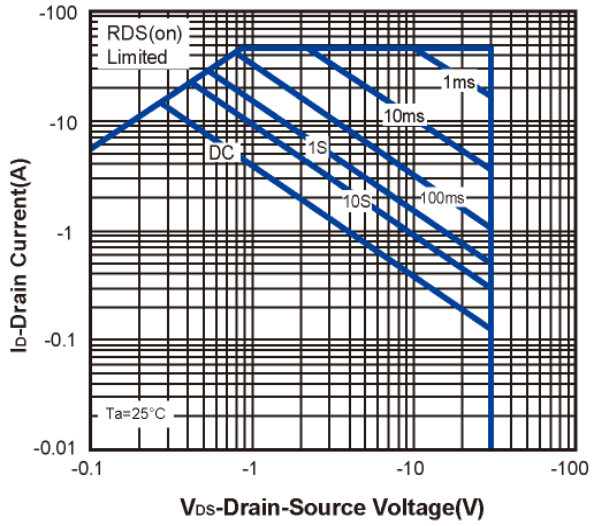
Gate Charge



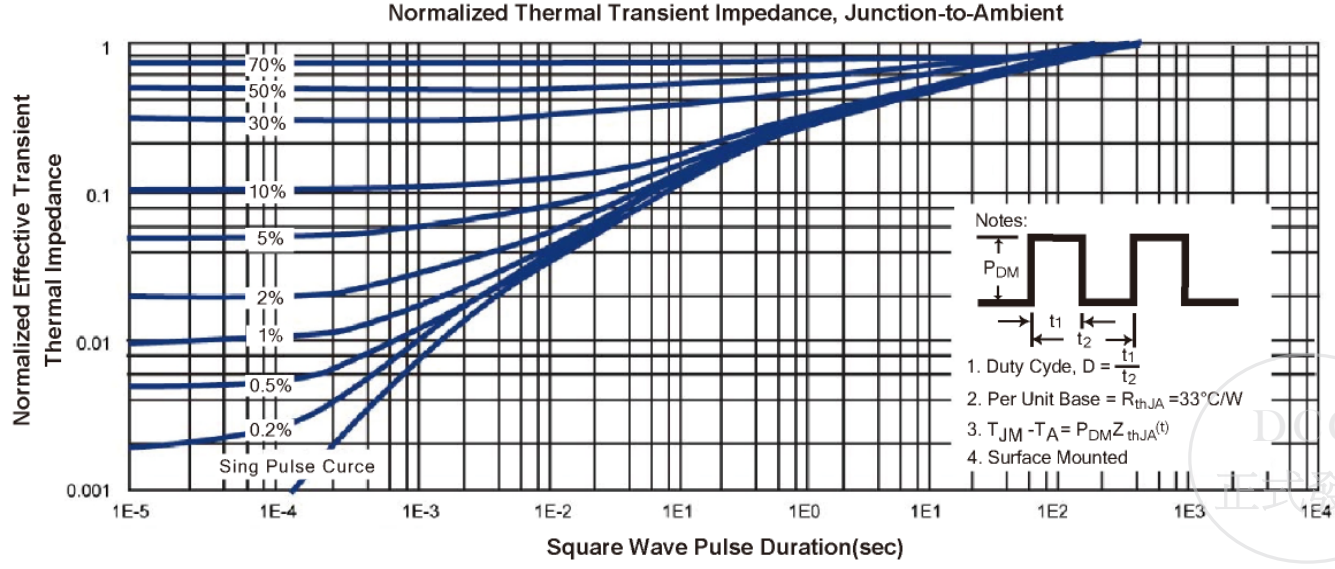
Body-diode characteristics



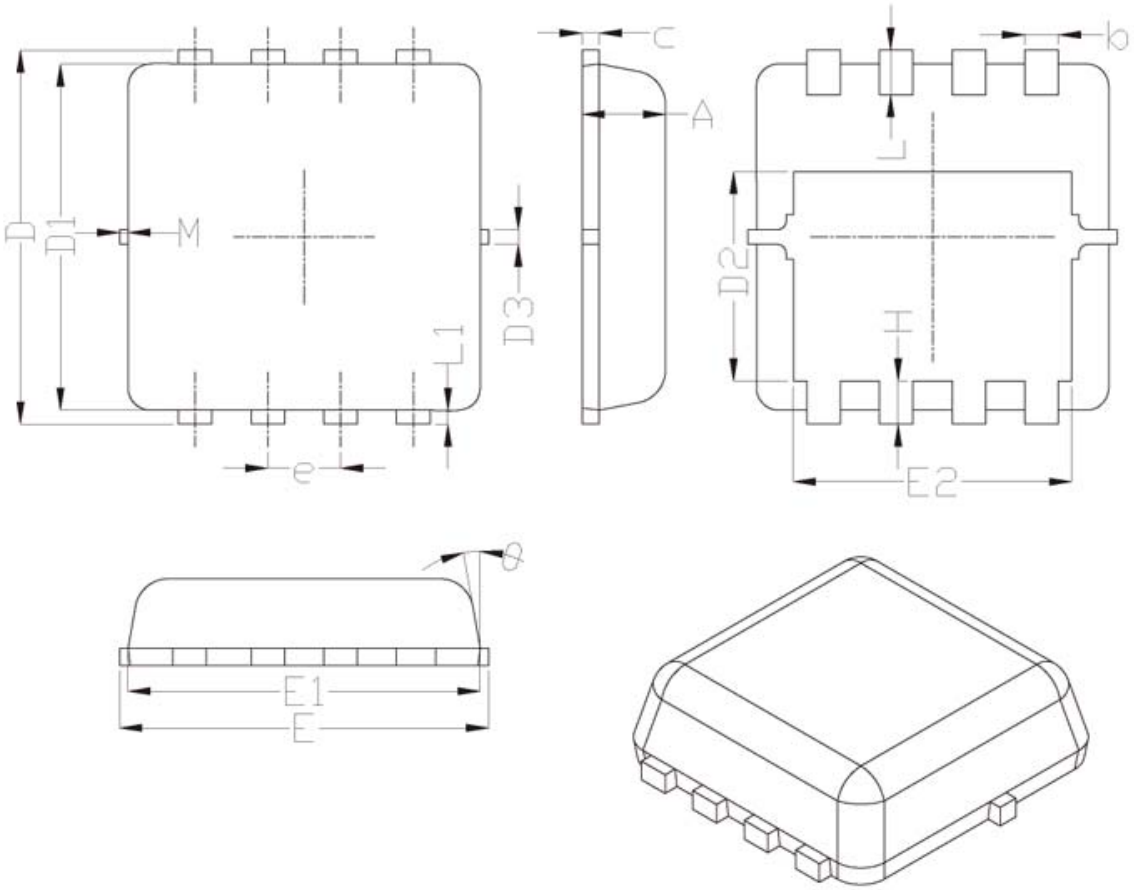
Maximum Forward Biased Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



DFN(S) 3.3x3.3 Package Outline



SYMBOL	DIMENSIONAL REQMTS		
	MIN	NOM	MAX
A	0.70	0.75	0.80
b	0.25	0.30	0.35
c	0.10	0.15	0.25
D	3.25	3.35	3.45
D1	3.00	3.10	3.20
D2	1.78	1.88	1.98
D3	---	0.13	---
E	3.20	3.30	3.40
E1	3.00	3.15	3.20
E2	2.39	2.49	2.59
e		0.65BSC	
H	0.30	0.39	0.50
L	0.30	0.40	0.50
L1	---	0.13	---
θ	---	10°	12°
M	*	*	0.15
* Not specified			